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CCS L 30

SJ

**INDUSTRY STANDARD OF THE
PEOPLE'S REPUBLIC OF CHINA**

SJ/T 11725-2018

**Thermal conduction epoxy composites material copper-clad
laminated sheets for printed circuits board**

印制电路用导热型覆铜箔环氧复合基层压板

(English Translation)

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Table of Contents

What this standard covers	1
Document data	2
Standards quoted by this document	3

What this standard covers

This standard specifies the classification, technical requirements, test methods, inspection rules, marking, packaging, storage and transportation of heat-conducting copper-clad epoxy composite laminates for printed circuits (hereinafter referred to as thermally conductive composite copper-clad laminates).

Document data

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